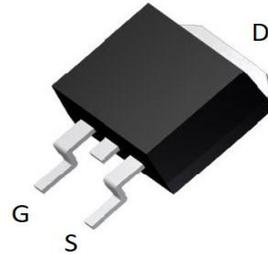


## 100V N-Channel SGT MOSFET

### Features

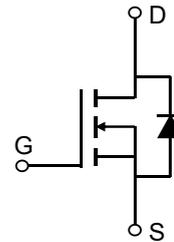
- 100V, 85A  
 $R_{DS(ON)}$  Typ= 10m $\Omega$  @  $V_{GS} = 10V$   
 $R_{DS(ON)}$  Typ= 13m $\Omega$  @  $V_{GS} = 4.5V$
- Advanced Split Gate Trench Technology
- Excellent  $R_{DS(ON)}$  and Low Gate Charge



**TO-263-3L**

### Applications

- Load Switch
- PWM Application
- Power Management



### Absolute Maximum Ratings (@ $T_J = 25^\circ C$ unless otherwise specified)

Symbol	Parameter	Value	Units
$V_{DS}$	Drain-to-Source Voltage	100	V
$V_{GS}$	Gate-to-Source Voltage	$\pm 20$	V
$I_D$	Continuous Drain Current	$T_C = 25^\circ C$	85
		$T_C = 100^\circ C$	51
$I_{DM}$	Pulsed Drain Current <sup>(1)</sup>	340	A
$E_{AS}$	Single Pulsed Avalanche Energy <sup>(2)</sup>	71	mJ
$P_D$	Power Dissipation	$T_C = 25^\circ C$	100
$R_{\theta JC}$	Thermal Resistance, Junction to Case	1.05	$^\circ C/W$
$T_J, T_{STG}$	Junction & Storage Temperature Range	-55 to 150	$^\circ C$



## 100V N-Channel SGT MOSFET

Electrical Characteristics ( $T_J = 25^\circ\text{C}$  unless otherwise specified)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
<b>Off Characteristics</b>						
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	$I_D = 250\mu\text{A}, V_{GS} = 0\text{V}$	100	-	-	V
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS} = 100\text{V}, V_{GS} = 0\text{V}$	-	-	1.0	$\mu\text{A}$
$I_{GSS}$	Gate-Body Leakage Current	$V_{DS} = 0\text{V}, V_{GS} = \pm 20\text{V}$	-	-	$\pm 100$	nA
<b>On Characteristics</b>						
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250\mu\text{A}$	1.0	1.7	2.5	V
$R_{DS(ON)}$	Static Drain-Source ON-Resistance <sup>(3)</sup>	$V_{GS} = 10\text{V}, I_D = 30\text{A}$	-	10.0	13.0	$\text{m}\Omega$
		$V_{GS} = 4.5\text{V}, I_D = 25\text{A}$	-	13.0	17.0	$\text{m}\Omega$
<b>Dynamic Characteristics</b>						
$C_{iss}$	Input Capacitance	$V_{GS} = 0\text{V}, V_{DS} = 25\text{V},$ $f = 1\text{MHz}$	-	1500	-	pF
$C_{oss}$	Output Capacitance		-	840	-	pF
$C_{riss}$	Reverse Transfer Capacitance		-	30	-	pF
$Q_g$	Total Gate Charge	$V_{GS} = 0 \text{ to } 10\text{V}$ $V_{DS} = 50\text{V}, I_D = 15\text{A}$	-	35	-	nC
$Q_{gs}$	Gate Source Charge		-	4.5	-	nC
$Q_{gd}$	Gate Drain ("Miller") Charge		-	8	-	nC
<b>Switching Characteristics</b>						
$t_{d(on)}$	Turn-On Delay Time	$V_{GS} = 10\text{V}, V_{DD} = 50\text{V}$ $I_D = 15\text{A}, R_{GEN} = 3\Omega$	-	16	-	ns
$t_r$	Turn-On Rise Time		-	13	-	ns
$t_{d(off)}$	Turn-Off Delay Time		-	37	-	ns
$t_f$	Turn-Off Fall Time		-	17	-	ns
<b>Drain-Source Diode Characteristics and Max Ratings</b>						
$I_S$	Maximum Continuous Drain to Source Diode Forward Current		-	-	85	A
$I_{SM}$	Maximum Pulsed Drain to Source Diode Forward Current		-	-	340	A
$V_{SD}$	Drain to Source Diode Forward Voltage	$V_{GS} = 0\text{V}, I_S = 30\text{A}$	-	-	1.2	V
$t_{rr}$	Body Diode Reverse Recovery Time	$I_F = 12\text{A}, di/dt = 100\text{A}/\mu\text{s}$	-	38	-	ns
$Q_{rr}$	Body Diode Reverse Recovery Charge	$I_F = 12\text{A}, di/dt = 100\text{A}/\mu\text{s}$	-	35	-	nC

- Notes:
1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.
  2.  $E_{AS}$  condition: Starting  $T_J = 25^\circ\text{C}$ ,  $V_{DD} = 50\text{V}$ ,  $V_G = 10\text{V}$ ,  $R_G = 25\text{ohm}$ ,  $L = 0.5\text{mH}$ ,  $I_{AS} = 16\text{A}$
  3. Pulse Test: Pulse Width  $\leq 300\mu\text{s}$ , Duty Cycle  $\leq 0.5\%$ .



## 100V N-Channel SGT MOSFET

### Typical Performance Characteristics

Figure 1: Output Characteristics

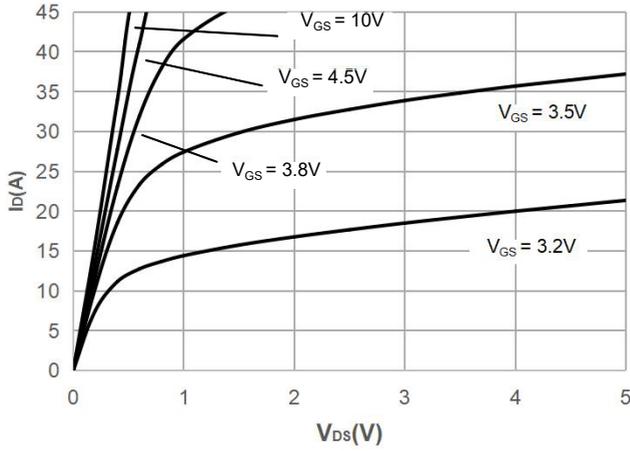


Figure 2: Typical Transfer Characteristics

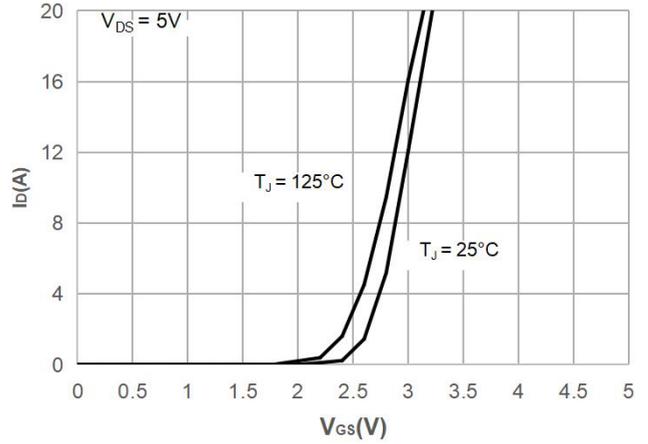


Figure 3: On-resistance vs. Drain Current

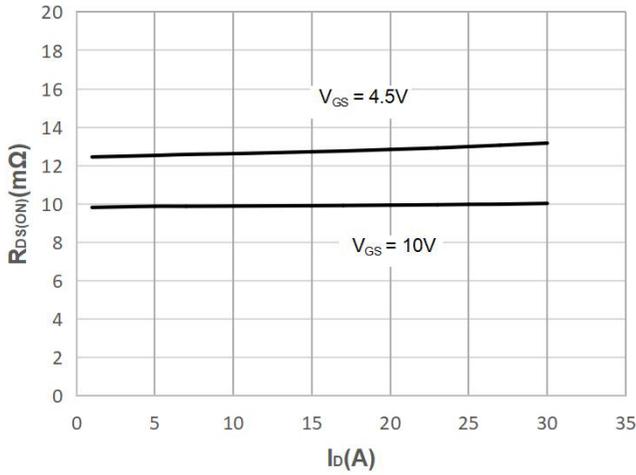


Figure 4: Body Diode Characteristics

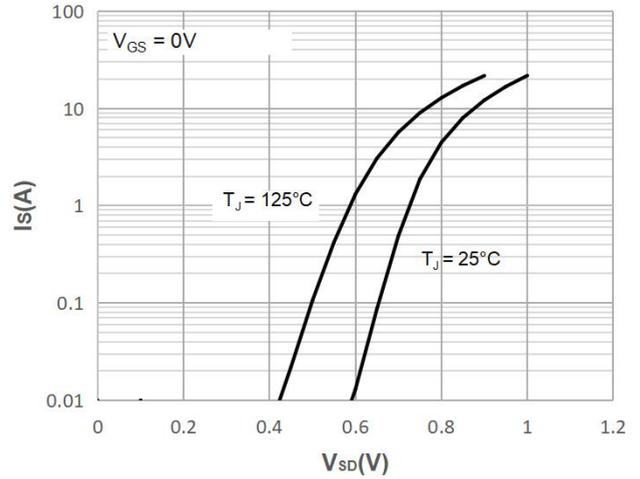


Figure 5: Gate Charge Characteristics

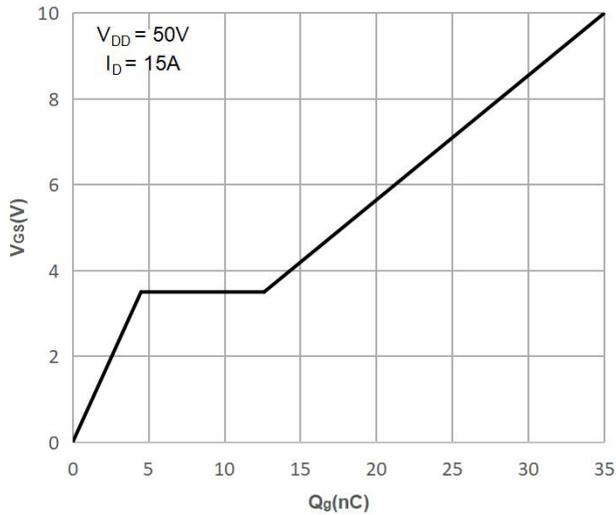
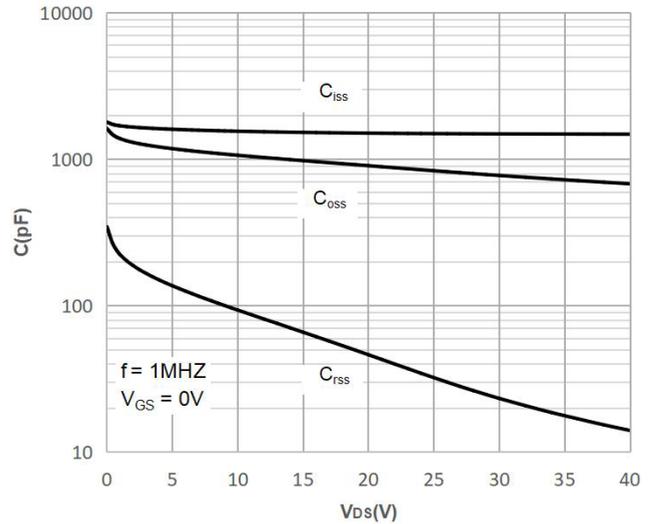


Figure 6: Capacitance Characteristics



## 100V N-Channel SGT MOSFET

### Typical Performance Characteristics

Figure 7: Normalized Breakdown voltage vs. Junction Temperature

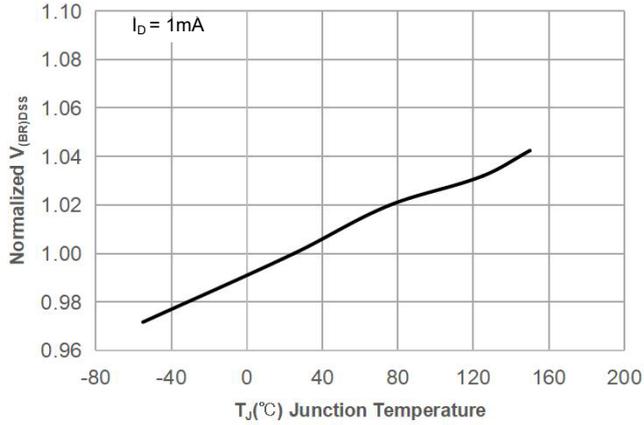


Figure 8: Normalized on Resistance vs. Junction Temperature

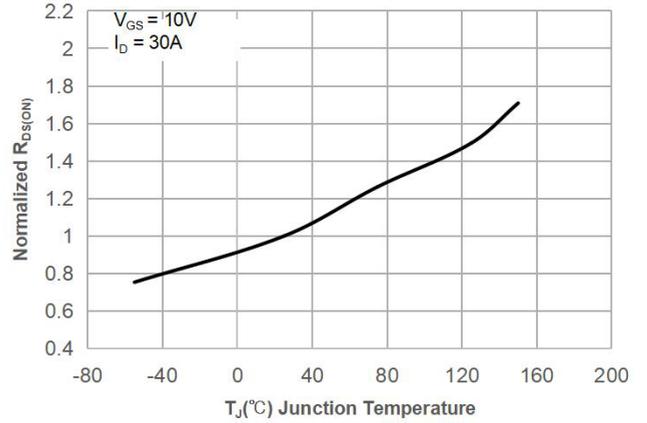


Figure 9: Maximum Safe Operating Area

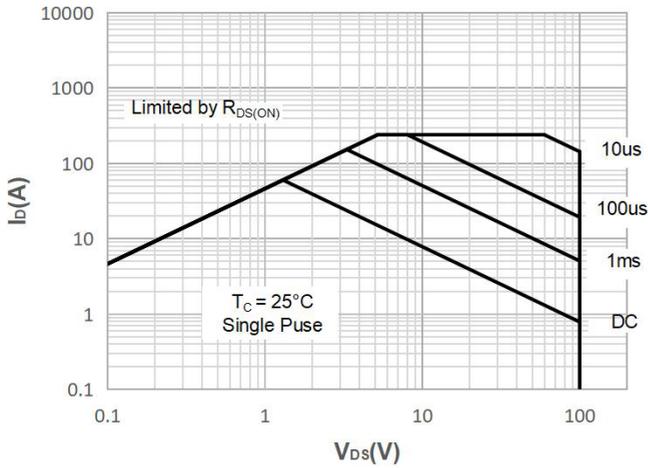


Figure 10: Current De-rating

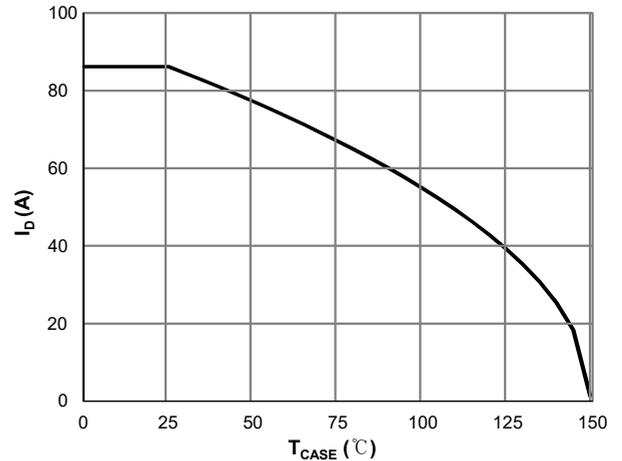


Figure 11: Normalized Maximum Transient Thermal Impedance

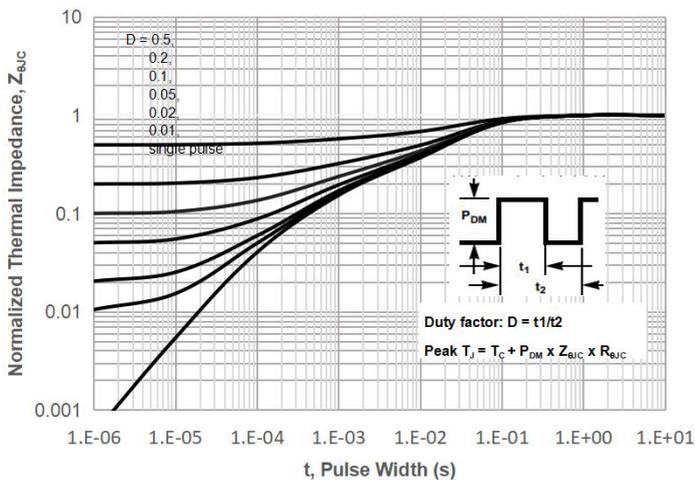
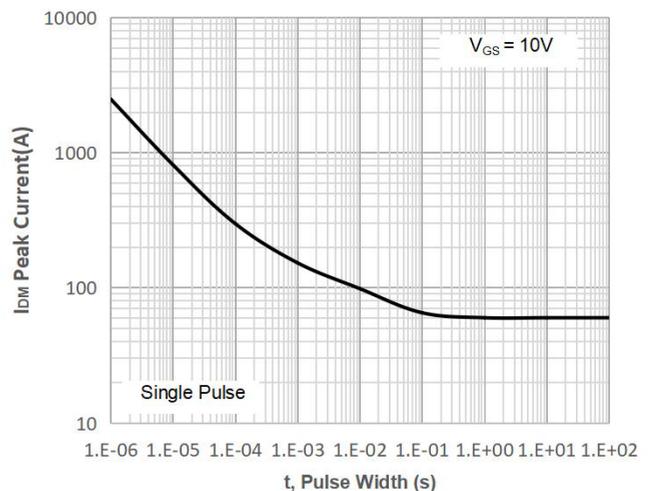


Figure 12: Peak Current Capacity



## 100V N-Channel SGT MOSFET

### Test Circuit

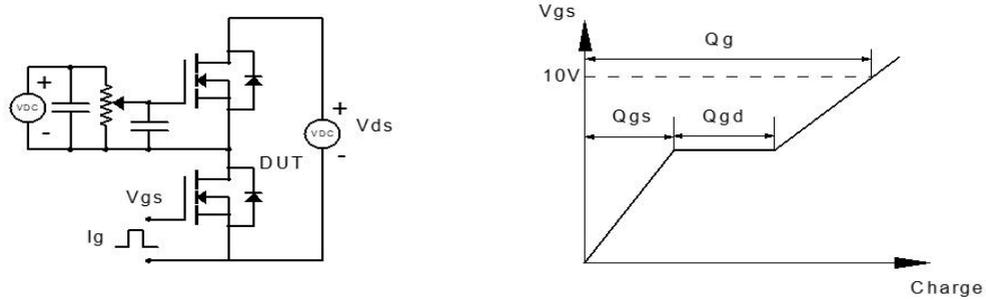


Figure 1: Gate Charge Test Circuit & Waveform

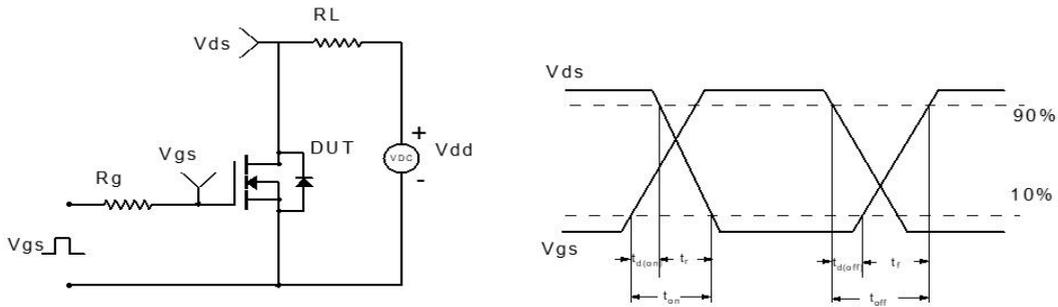


Figure 2: Resistive Switching Test Circuit & Waveform

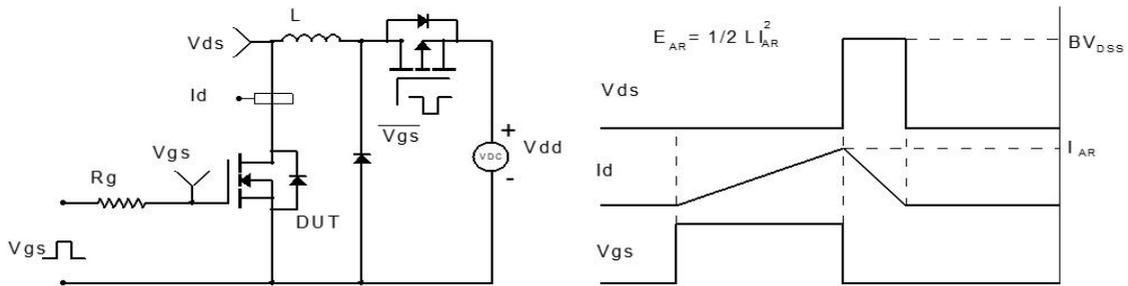


Figure 3: Unclamped Inductive Switching Test Circuit & Waveform

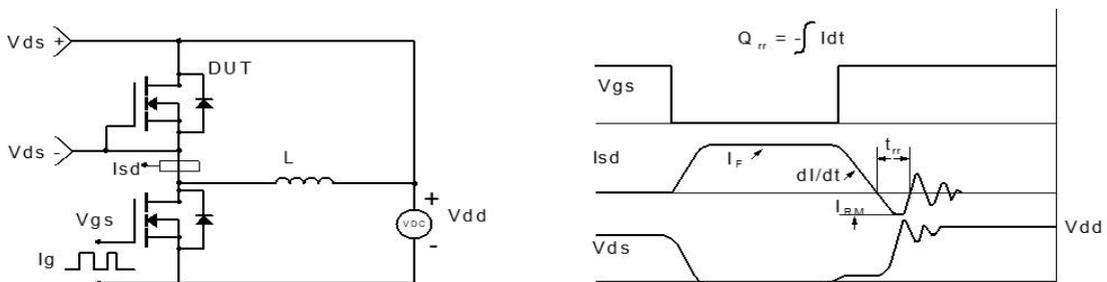
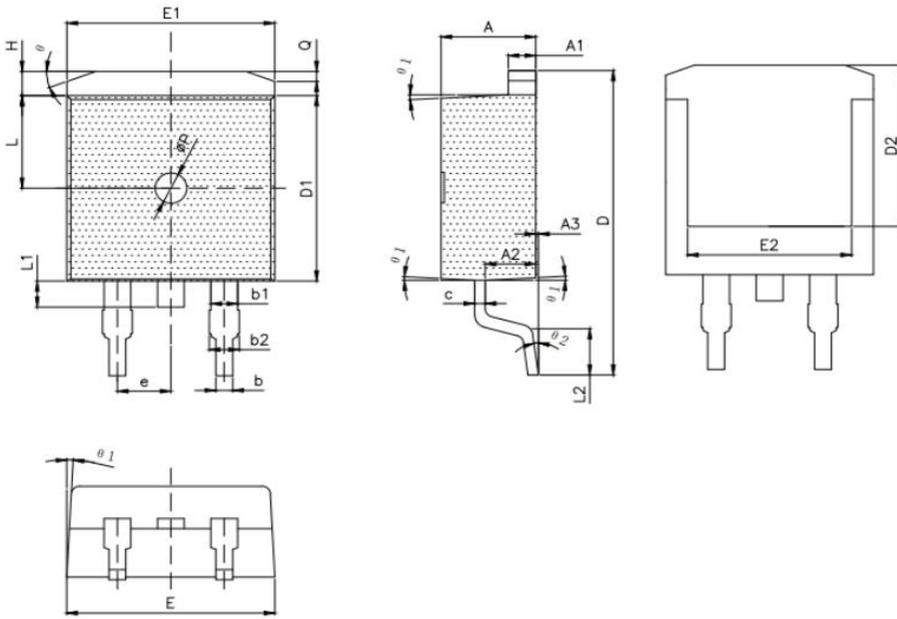


Figure 4: Diode Recovery Test Circuit & Waveform

## 100V N-Channel SGT MOSFET

### Package Mechanical Data(TO-263-3L)



SYMBOL	MILLIMETER		
	MIN	NOM	MAX
A	4.40	4.50	4.60
A1	1.20	1.30	1.40
A2	2.30	2.40	2.50
A3	0.03	0.13	0.23
b	0.70	0.80	0.90
b1	1.21	1.27	1.40
b2	1.25	1.35	1.45
c	0.40	0.50	0.60
D	14.80	15.10	15.40
D1	9.10	9.20	9.30
D2	8.00	--	--
E	9.70	9.90	10.20
E1	9.68	9.88	10.08
E2	7.80	--	--
e	2.54 (BSC)		
H	1.00	1.20	1.40
L	4.30	4.60	4.90
L1	1.10	1.30	1.50
L2	2.10	2.30	2.50
φP	1.40	1.50	1.60
Q	0.50 (REF)		
θ	16°	20°	24°
θ1	1°	3°	5°
θ2	0°	--	9°